



ProLight PQ2N-4LxE-WFC
4W Power LED
Technical Datasheet
Version: 1.2

ProLight Opto PQ2N Series

Features

- Best Moisture Sensitivity: JEDEC Level 1
- RoHS compliant
- Very wide Viewing Angle

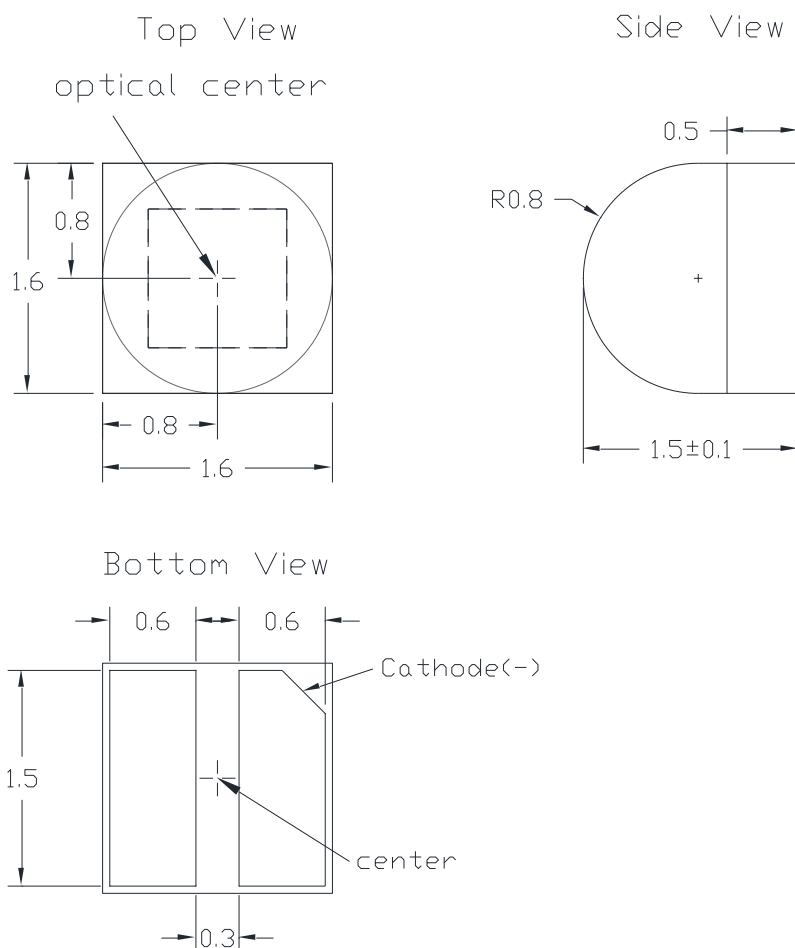
Main Applications

- Commercial Lighting
- Indoor Lighting
- Outdoor Lighting
- Architectural
- Horticulture
- Consumer Portable
- High-End Portable

Introduction

- ProLight 1616, is one of the smallest high power LED footprint available by ProLight Opto, has offered extended solid-state lighting design possibilities. The 1616's combination of consistent design across all configurations and its small size permit improved color mixing and optical control, compared to the larger 3535 LED. ProLight 1616 is designed with ProLight unique packaging technology which providing high stability reliability.
- 1616 qualifies as the JEDEC Level 1 MSL sensitivity level and suitable for SMD process, Pb free reflow soldering capability, and full compliance with EU education of Hazardous Substances (RoHS) legislation.

Emitter Mechanical Dimensions



Notes:

1. Drawing not to scale.
2. All dimensions are in millimeters.
3. Unless otherwise indicated, tolerances are $\pm 0.10\text{mm}$.
4. Please do not solder the emitter by manual hand soldering, otherwise it will damage the emitter.
5. **Please do not use a force of over 0.3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.**

Flux Characteristics, $T_j = 25^{\circ}\text{C}$

| Color | Part Number Emitter | Luminous Flux or Power | | | | | |
|------------|------------------------|------------------------|--------|--------------|--------|---------------|---------|
| | | @350mA | | Refer @700mA | | Refer @1000mA | |
| | | Min. | Typ. | Min. | Typ. | Min. | Typ. |
| Blue | PQ2N-4LBE-WFC | 35 lm | 47 lm | 58 lm | 78 lm | 74 lm | 99 lm |
| Royal Blue | PQ2N-4LDE-WFC | 435 mW | 560 mW | 740 mW | 955 mW | 980 mW | 1260 mW |

- ProLight maintains a tolerance of $\pm 7\%$ on flux and power measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

Electrical Characteristics, $T_j = 25^{\circ}\text{C}$

| Color | Min. | Forward Voltage V_F (V) | | | Refer @1000mA Typ. | Thermal Resistance Junction to Slug ($^{\circ}\text{C/W}$) |
|------------|------|---------------------------|------|----------------------|-----------------------|---|
| | | @350mA Typ. | Max. | Refer @700mA Typ. | | |
| Blue | 2.60 | 3.00 | 3.60 | 3.25 | 3.40 | 6 |
| Royal Blue | 2.60 | 3.10 | 3.60 | 3.40 | 3.60 | 6 |

- ProLight maintains a tolerance of $\pm 0.1\text{V}$ for Voltage measurements.

Optical Characteristics at 350mA, $T_j = 25^{\circ}\text{C}$

| Radiation Pattern | Color | Dominant Wavelength λ_D | | | Total included Angle (degrees) $\theta_{0.90V}$ | Viewing Angle (degrees) $2\theta_{1/2}$ |
|----------------------|------------|---------------------------------|----------|--------|---|--|
| | | Min. | Typ. | Max. | | |
| Lambertian | Blue | 470 nm | 477.5 nm | 485 nm | 160 | 130 |
| | Royal Blue | 450 nm | 455 nm | 460 nm | 160 | 130 |

- ProLight maintains a tolerance of $\pm 1\text{nm}$ for dominant wavelength measurements.

Absolute Maximum Ratings

| Parameter | Blue/Royal Blue |
|--|---|
| DC Forward Current (mA) | 1000 |
| Peak Pulsed Forward Current (mA) | 1500 (less than 1/10 duty cycle @ 1KHz) |
| ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7) | 2KV |
| LED Junction Temperature | 125°C |
| Operating Board Temperature at Maximum DC Forward Current | -40°C - 105°C |
| Storage Temperature | -40°C - 120°C |
| Soldering Temperature | JEDEC 020c 260°C |
| Allowable Reflow Cycles | 3 |
| Reverse Voltage | Not designed to be driven in reverse bias |

Radiometric Power Bin Structure at 350mA

| Color | Bin Code | Minimum Radiometric Power (mW) | Maximum Radiometric Power (mW) | Available Color Bins |
|------------|----------|-----------------------------------|-----------------------------------|-------------------------|
| Royal Blue | Q | 435 | 515 | All |
| | R | 515 | 635 | [1] |
| | S | 635 | 755 | [1] |

- ProLight maintains a tolerance of $\pm 7\%$ on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- ^[1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order possibility.

Photometric Luminous Flux Bin Structure at 350mA

| Color | Bin Code | Minimum Photometric Flux (lm) | Maximum Photometric Flux (lm) | Available Color Bins |
|-------|----------|----------------------------------|----------------------------------|-------------------------|
| Blue | Q | 35 | 39.8 | 3,4 ^[1] |
| | R | 39.8 | 51.7 | 4,5 ^[1] |
| | S1 | 51.7 | 58.9 | [1] |
| | S2 | 58.9 | 67.2 | [1] |

- ProLight maintains a tolerance of $\pm 7\%$ on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- ^[1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order possibility.

Dominant Wavelength Bin Structure

| Color | Bin Code | Minimum Dominant Wavelength (nm) | Maximum Dominant Wavelength (nm) |
|------------|----------|----------------------------------|----------------------------------|
| Blue | 3 | 470 | 475 |
| | 4 | 475 | 480 |
| | 5 | 480 | 485 |
| Royal Blue | 5 | 450 | 455 |
| | 6 | 455 | 460 |

- ProLight maintains a tolerance of $\pm 1\text{nm}$ for dominant wavelength measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Forward Voltage Bin Structure at 350mA

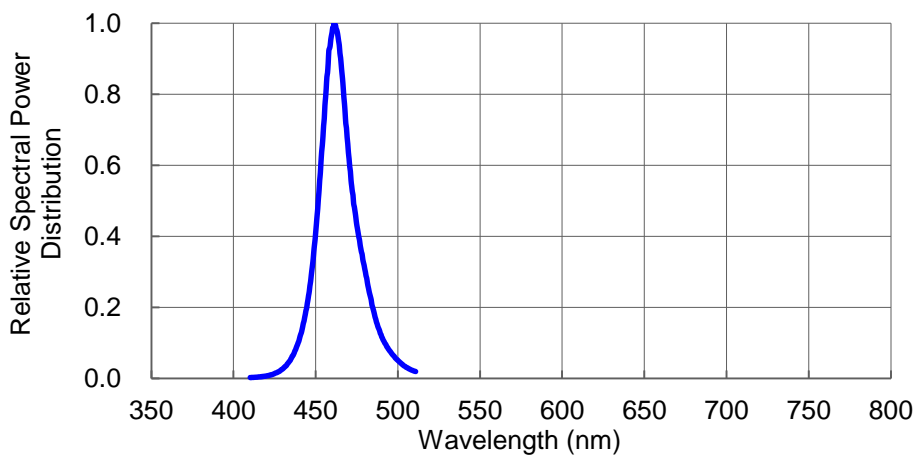
| Color | Bin Code | Minimum Voltage (V) | Maximum Voltage (V) |
|------------|----------|---------------------|---------------------|
| Blue | a | 2.60 | 2.85 |
| | A | 2.85 | 3.10 |
| | B | 3.10 | 3.35 |
| | D | 3.35 | 3.60 |
| Royal Blue | a | 2.60 | 2.85 |
| | A | 2.85 | 3.10 |
| | B | 3.10 | 3.35 |
| | D | 3.35 | 3.60 |

- ProLight maintains a tolerance of $\pm 0.1\text{V}$ for Voltage measurements.

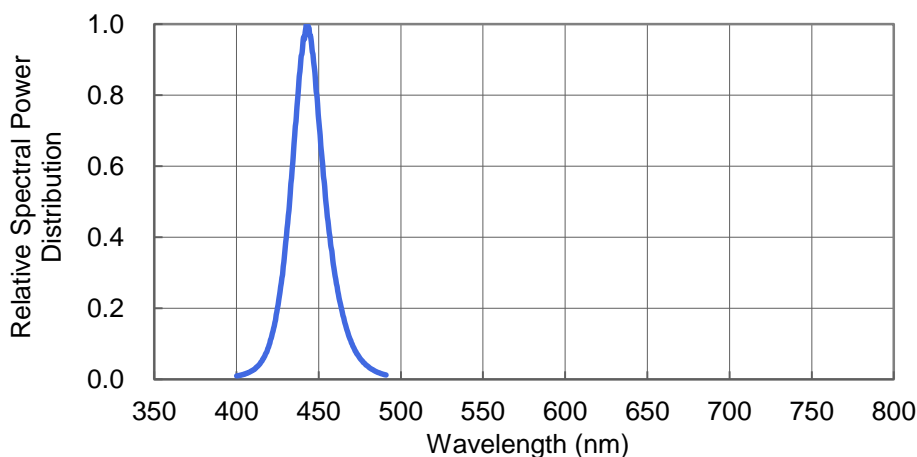
Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.

Color Spectrum, $T_j = 25^\circ\text{C}$

1. Blue

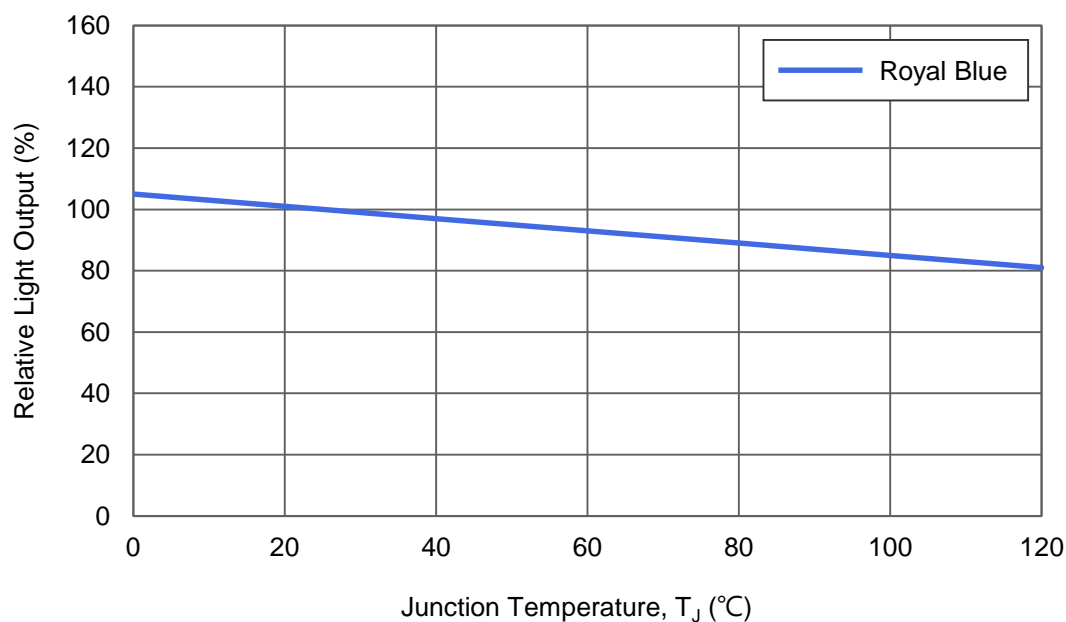
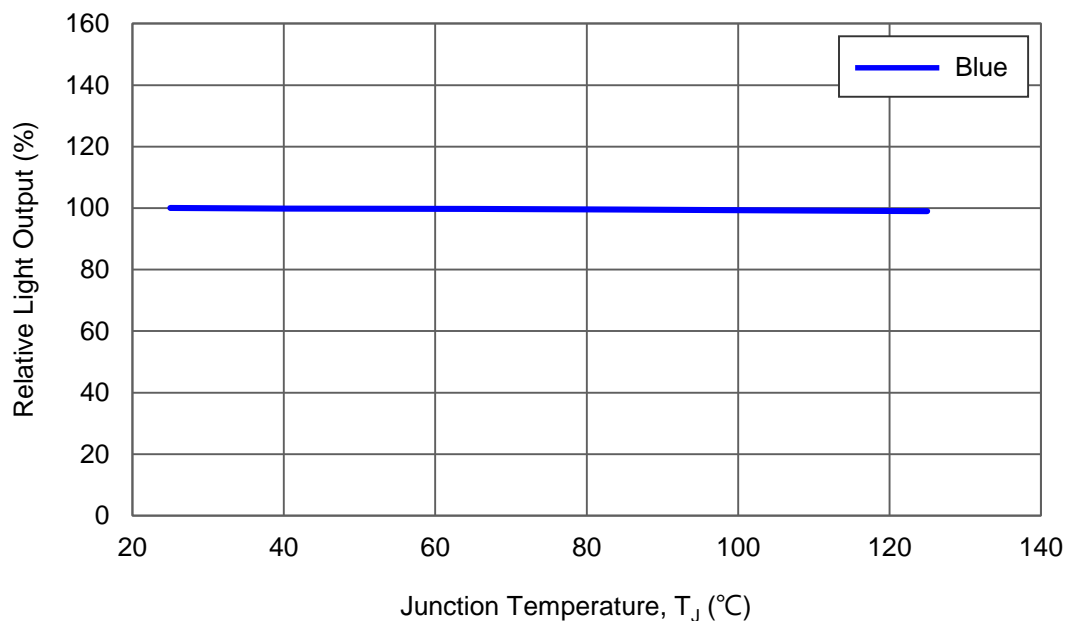


2. Royal Blue



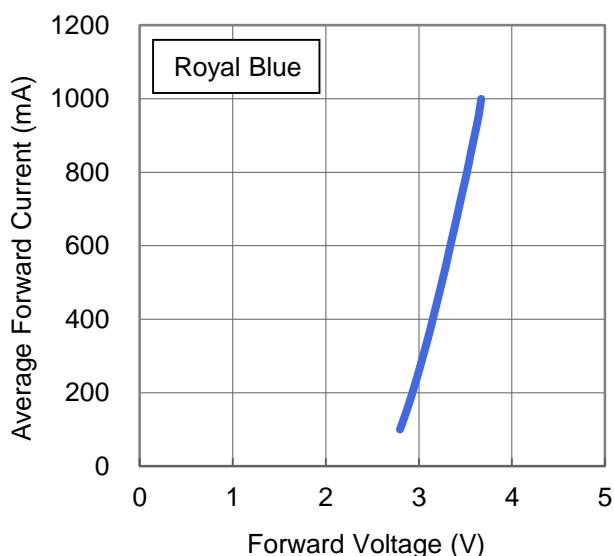
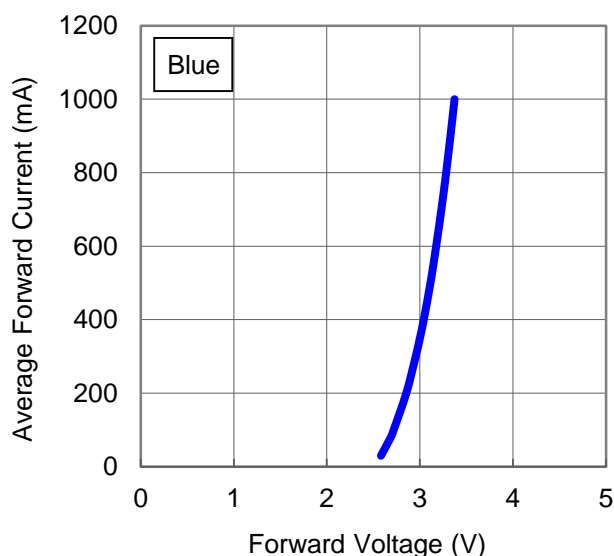
Light Output Characteristics

Relative Light Output vs. Junction Temperature at 350mA

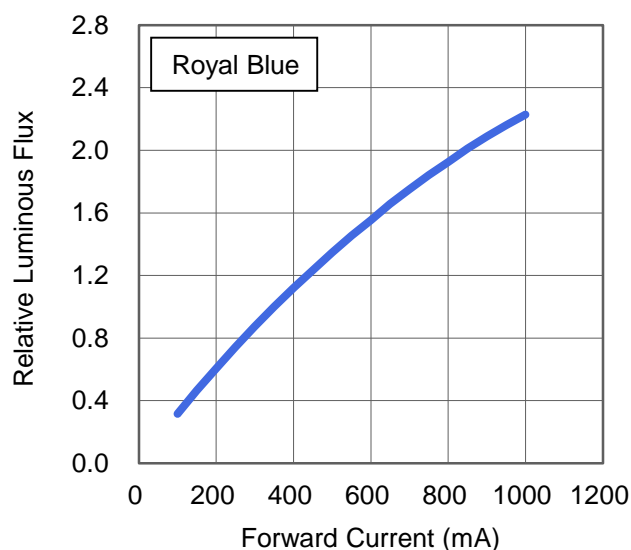
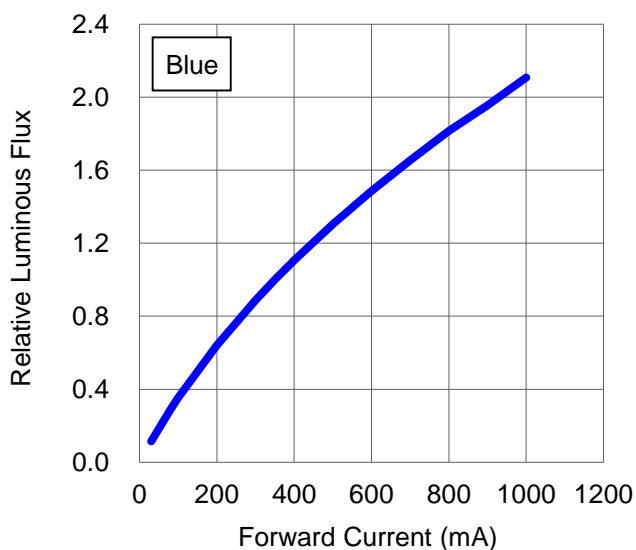


Forward Current Characteristics, $T_j = 25^\circ\text{C}$

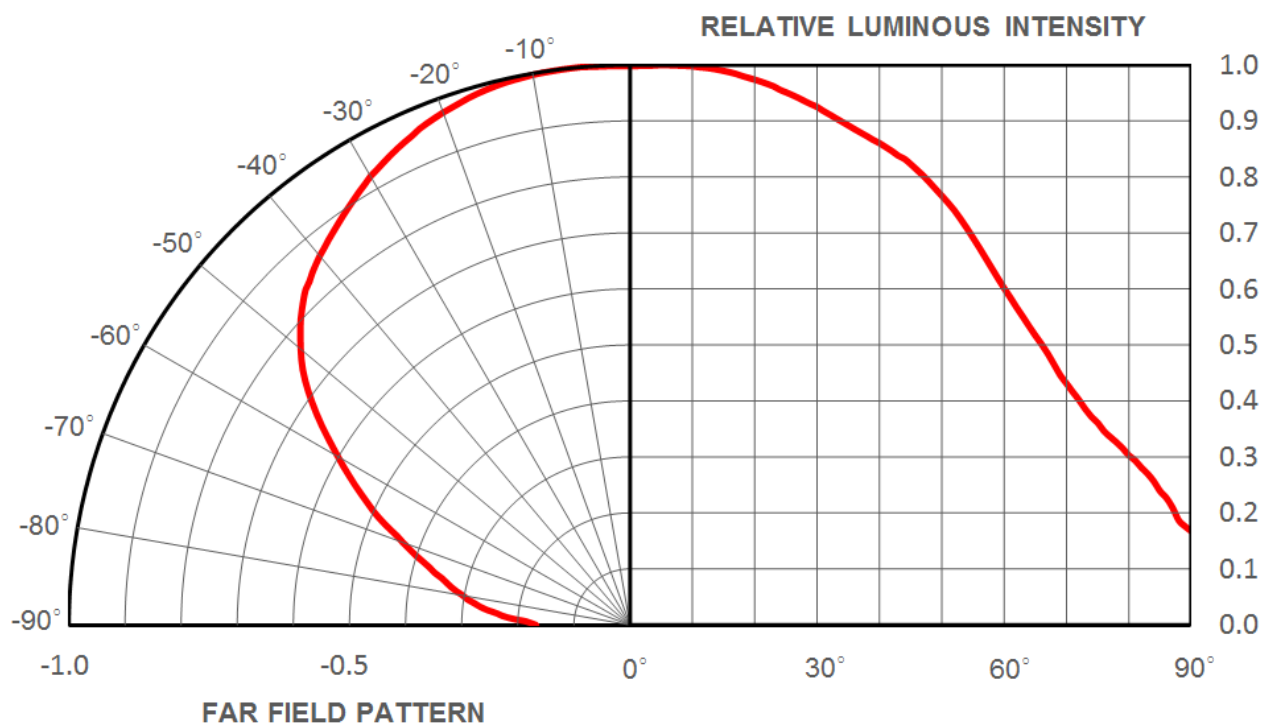
1. Forward Voltage vs. Forward Current



2. Forward Current vs. Normalized Relative Luminous Flux



Typical Representative Spatial Radiation Pattern



Moisture Sensitivity Level - JEDEC Level 1

| Level | Floor Life | | Soak Requirements | | | |
|-------|------------|---------------------------------------|-------------------|----------------------------------|-------------------------|------------|
| | | | Standard | | Accelerated Environment | |
| | Time | Conditions | Time (hours) | Conditions | Time (hours) | Conditions |
| 1 | Unlimited | $\leq 30^{\circ}\text{C}$ / 85% RH | 168 +5/-0 | 85°C / 85% RH | NA | NA |

- The standard soak time includes a default value of 24 hours for semiconductor manufacture's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

| Level | Floor Life | | Soak Requirements | | | |
|-------|------------------------|---------------------------------------|------------------------|----------------------------------|-------------------------|----------------------------------|
| | | | Standard | | Accelerated Environment | |
| | Time | Conditions | Time (hours) | Conditions | Time (hours) | Conditions |
| 1 | Unlimited | $\leq 30^{\circ}\text{C}$ / 85% RH | 168 +5/-0 | 85°C / 85% RH | NA | NA |
| 2 | 1 year | $\leq 30^{\circ}\text{C}$ / 60% RH | 168 +5/-0 | 85°C / 60% RH | NA | NA |
| 2a | 4 weeks | $\leq 30^{\circ}\text{C}$ / 60% RH | 696 +5/-0 | 30°C / 60% RH | 120 +1/-0 | 60°C / 60% RH |
| 3 | 168 hours | $\leq 30^{\circ}\text{C}$ / 60% RH | 192 +5/-0 | 30°C / 60% RH | 40 +1/-0 | 60°C / 60% RH |
| 4 | 72 hours | $\leq 30^{\circ}\text{C}$ / 60% RH | 96 +2/-0 | 30°C / 60% RH | 20 +0.5/-0 | 60°C / 60% RH |
| 5 | 48 hours | $\leq 30^{\circ}\text{C}$ / 60% RH | 72 +2/-0 | 30°C / 60% RH | 15 +0.5/-0 | 60°C / 60% RH |
| 5a | 24 hours | $\leq 30^{\circ}\text{C}$ / 60% RH | 48 +2/-0 | 30°C / 60% RH | 10 +0.5/-0 | 60°C / 60% RH |
| 6 | Time on Label (TOL) | $\leq 30^{\circ}\text{C}$ / 60% RH | Time on Label (TOL) | 30°C / 60% RH | NA | NA |

Qualification Reliability Testing

| Stress Test | Stress Conditions | Stress Duration | Failure Criteria |
|---|--|-----------------|----------------------------|
| Room Temperature Operating Life (RTOL) | 25°C, $I_F = \text{max DC}$ (Note 1) | 1000 hours | Note 2 |
| Wet High Temperature Operating Life (WHTOL) | 85°C/60%RH, $I_F = \text{max DC}$ (Note 1) | 1000 hours | Note 2 |
| Wet High Temperature Storage Life (WHTSL) | 85°C/85%RH, non-operating | 1000 hours | Note 2 |
| High Temperature Storage Life (HTSL) | 110°C, non-operating | 1000 hours | Note 2 |
| Low Temperature Storage Life (LTSL) | -40°C, non-operating | 1000 hours | Note 2 |
| Non-operating Temperature Cycle (TMCL) | -40°C to 120°C, 30 min. dwell, <5 min. transfer | 200 cycles | Note 2 |
| Mechanical Shock | 1500 G, 0.5 msec. pulse, 5 shocks each 6 axis | | Note 3 |
| Natural Drop | On concrete from 1.2 m, 3X | | Note 3 |
| Variable Vibration Frequency | 10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis | | Note 3 |
| Solder Heat Resistance (SHR) | 260°C \pm 5°C, 10 sec. | | Note 3 |
| Solderability | Steam age for 16 hrs., then solder dip at 260°C for 5 sec. | | Solder coverage on lead |

Notes:

- Depending on the maximum derating curve.
- Criteria for judging failure

| Item | Test Condition | Criteria for Judgement | |
|---|-----------------------|------------------------|---------------------|
| | | Min. | Max. |
| Forward Voltage (V_F) | $I_F = \text{max DC}$ | -- | Initial Level x 1.1 |
| Luminous Flux or Radiometric Power (Φ_V) | $I_F = \text{max DC}$ | Initial Level x 0.7 | -- |
| Reverse Current (I_R) | $V_R = 5V$ | -- | 50 μA |

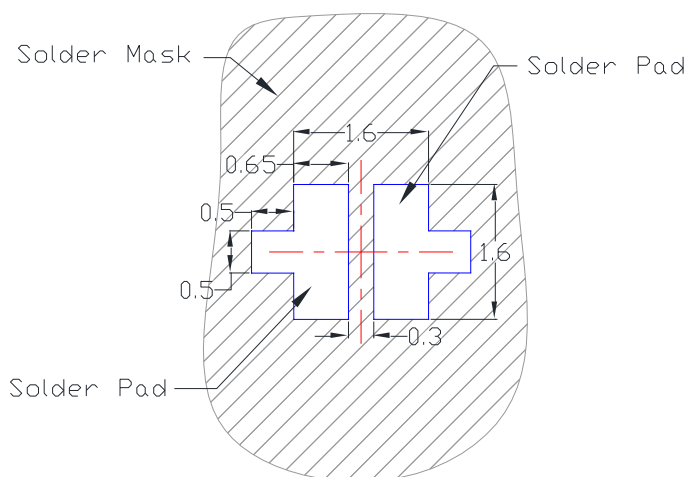
* The test is performed after the LED is cooled down to the room temperature.

- A failure is an LED that is open or shorted.

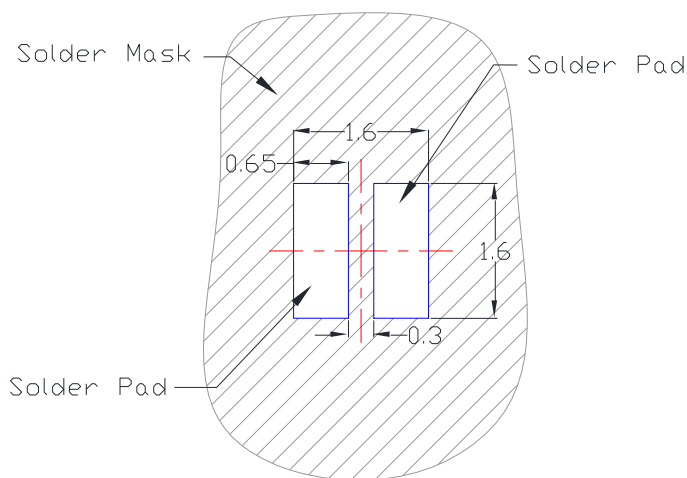
Recommended Solder Pad Design

Standard Emitter

TYPE A.



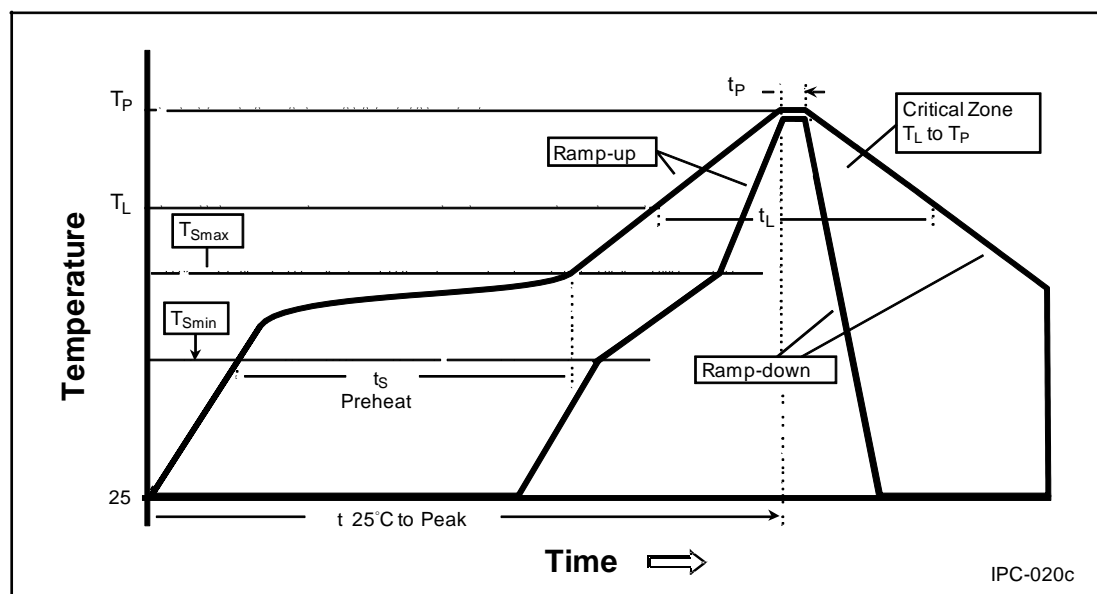
TYPE B.



- All dimensions are in millimeters.

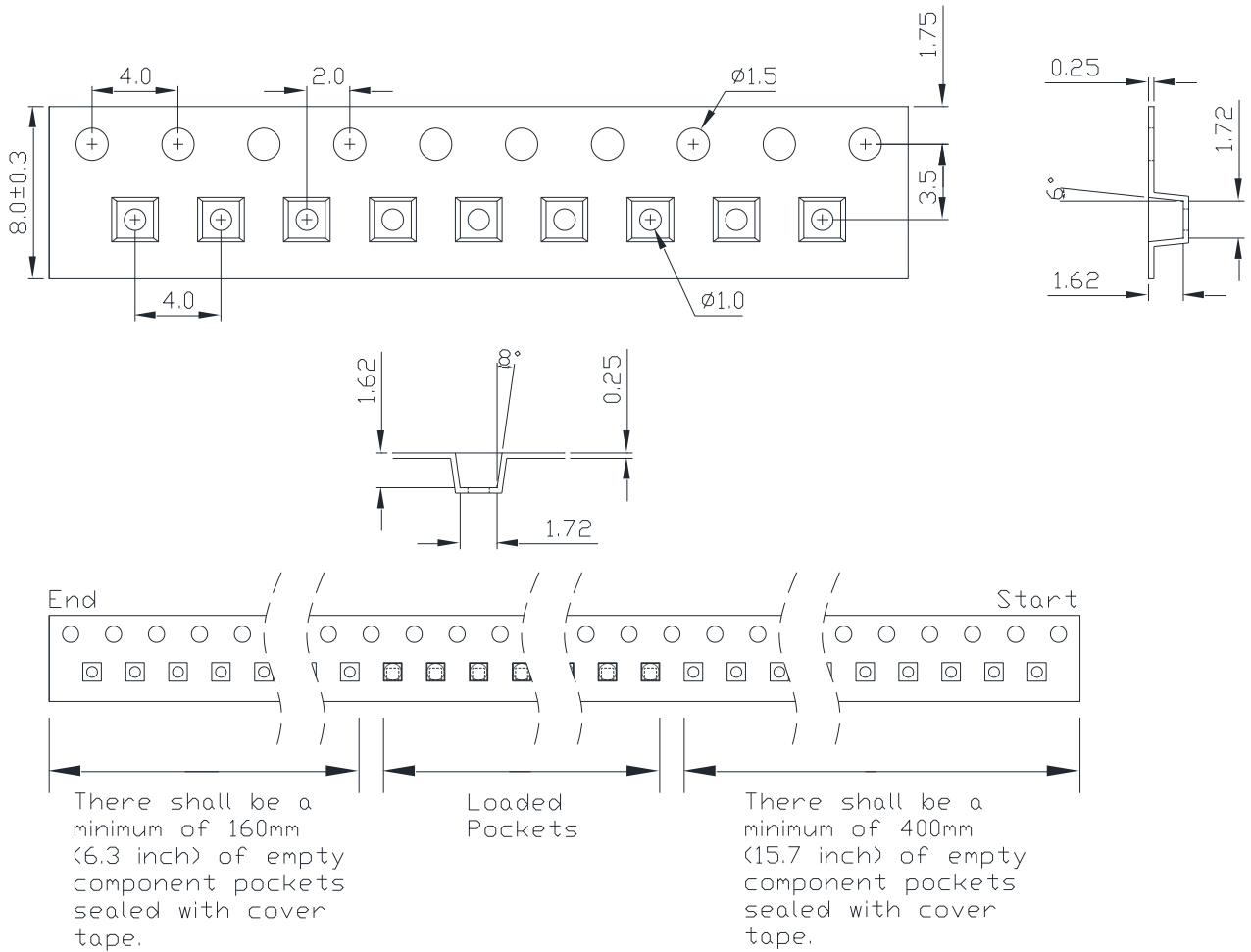
Reflow Soldering Condition

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|---|----------------------------------|----------------------------------|
| Average Ramp-Up Rate (T_{Smax} to T_P) | 3°C / second max. | 3°C / second max. |
| Preheat <ul style="list-style-type: none"> – Temperature Min (T_{Smin}) – Temperature Max (T_{Smax}) – Time (t_{Smin} to t_{Smax}) | 100°C 150°C 60-120 seconds | 150°C 200°C 60-180 seconds |
| Time maintained above: <ul style="list-style-type: none"> – Temperature (T_L) – Time (t_L) | 183°C 60-150 seconds | 217°C 60-150 seconds |
| Peak/Classification Temperature (T_P) | 240°C | 260°C |
| Time Within 5°C of Actual Peak Temperature (t_p) | 10-30 seconds | 20-40 seconds |
| Ramp-Down Rate | 6°C/second max. | 6°C/second max. |
| Time 25°C to Peak Temperature | 6 minutes max. | 8 minutes max. |



- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.

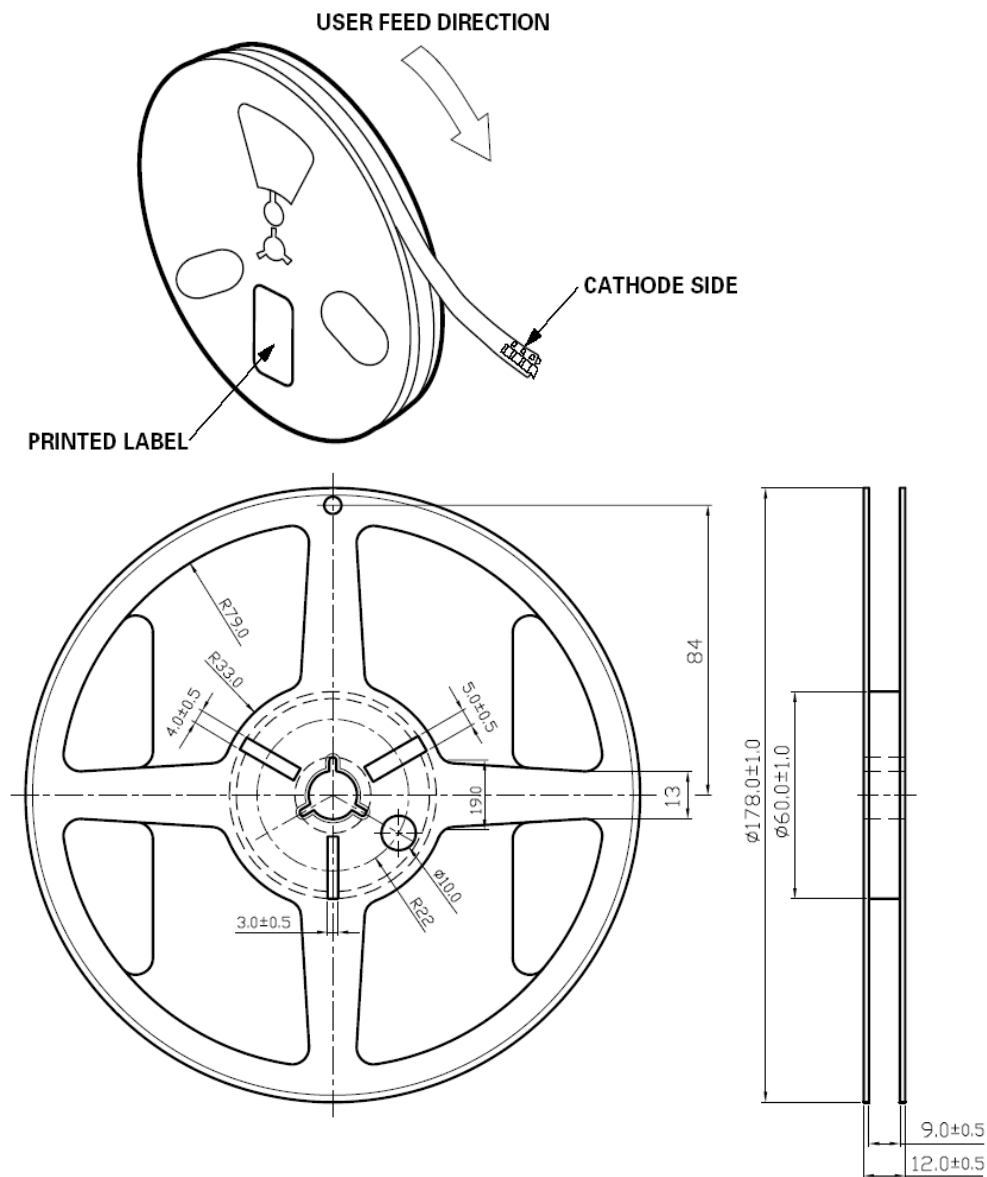
Emitter Reel Packaging



Notes:

1. Drawing not to scale.
2. All dimensions are in millimeters.
3. Unless otherwise indicated, tolerances are ± 0.10 mm.

Emitter Reel Packaging



Notes:

1. Empty component pockets sealed with top cover tape.
2. 1000 and 2000 pieces per reel.
3. Drawing not to scale.
4. All dimensions are in millimeters.

Precaution for Use

- Storage
Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30 °C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseat the MBB.
- The slug is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- **We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.**
- **Do not use solder pastes with post reflow flux residue > 47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.**
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decided after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets.
<http://www.prolightopto.com/>

Handling of Silicone Lens LEDs

Notes for handling of silicone lens LEDs

- Please do not use a force of over 0.3kgf impact or pressure on the silicone lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the silicone lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the silicone lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the silicone lens must be prevented.
- Please do not mold over the silicone lens with another resin. (epoxy, urethane, etc)

